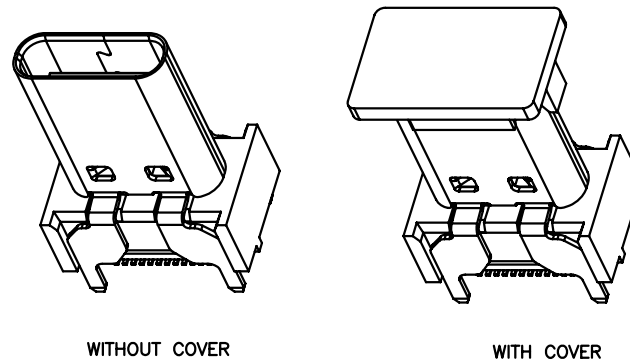
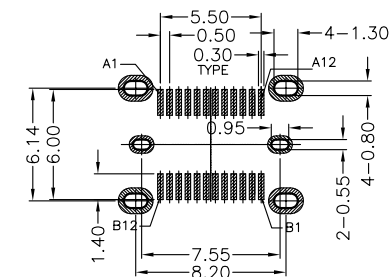
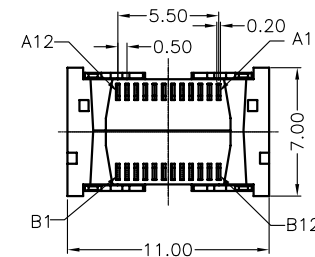
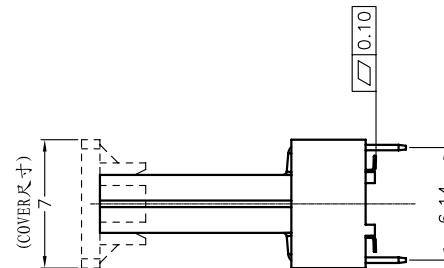




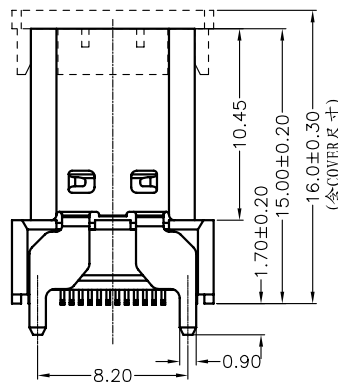
WITH COVER



KEEP OUT AREA



01: Au 1u"Min.
03: Au 3u"Min.
05: Au 5u"Min.
10: Au 10u"Min.
15: Au 15u"Min.
30: Au 30u"Min.



- 1.Contact Resistance:40mOHM Max.;
- 2.Dielectric Withstanding Voltage:100V AC For 1 Minute;
- 3.Insulation Resistance:100M OHM Min.;
- 4.Mating And Unmating Force:
Mating Force: 5~20N
Unmating Force: 8~20N;
6~20N AFTER TEST ;
- 5.Durability:10000 Cycles;

Item	Title	Material	Dispose	Remark
1	Shell	Stainless Steel	Ni:30u" Min.	
2	GND Plate	Stainless Steel		
3	Mid Plate	Stainless Steel		
4	Top Contact	Copper Alloy	Mating Area: See P/N Solder Tails: Matt Tin	
5	Bottom Contact	Copper Alloy		
6	Insulator	High Temperature Plastic	UL 94V-0	Black

$X. \pm 0.30$	APPD: Henry	 泰康电子 TECOM
$.X \pm 0.20$	CHKD: Lebon	
$.XX \pm 0.15$	DR: Lei	
$.XXX \pm 0.10$		
$X^* \pm 2^*$	TITLE: USB 3.1 TYPE C FEMALE VERTICAL H15.0mm SMT TYPE	
$.X^* \pm 1.5^*$	PART NO: A4Q2403-C-XX-R	
	UNITS: mm	SCALE: 3:1
	DWG NO: CUSTOMER DRAWING C-A4Q2403-C-XX-R	
		SHEET:10F1
		REV: X1

A	TE2018-XXXX	New Drawing	Lei	2018/03/06
REV	ECN NO	DESCRIPTION	DESIGN	DATE